## UNITED STATES

## DECLARATION FOR PATENT APPLICATION

Docket No. NECF 20.702

he subject matter which is c	laimed and for which a r	patent is sought on the inventi	or an original, first and joint inventor (if p	
SEMICONDUCTO	R INTEGRATED	CIRCUIT AND SEMI	CONDUCTOR SUBSTRATE OF	THE SAME
he specification of which				
(check one)	[x] is attached here	eto		
	[ ] was filed on		a	3
	Application Seri	ial No		
	and was amende	ed on		(if applicable).
hereby state that I have revi	ewed and understand the	e contents of the above identi	fied specification, including the claims, as	amended by an amendmen
eferred to above.				
acknowledge the duty to dis	sclose information which	h is material to the examination	on of this application in accordance with Ti	tle 37, Code of Federal
egulations §1.56(a).				
hereby claim foreign priorit	ty benefits under Title 35	5, United States Code, §119 o	f any foreign application(s) for patent or in	ventor's certificate listed b
nd have also identified belo	w any foreign applicatio	n for patent or inventor's cert	ificate having a filing date before that of th	e application on which pri-
claimed:				
				Priority Claimed
				rriority Claimed
	s)	Japan	31/10/2002	(Yan No
2002-318910	s) 	Japan (Country)	31/10/2002 (Day/Month/Year Filed)	Yes No
	s) 	Japan (Country)	(Day/Month/Year Filed)	Yes No
2002-318910	s)			Yes No
2002-318910	s)			
2002-318910 (Number)	s)	(Country)	(Day/Month/Year Filed)	
2002-318910 (Number)	s)	(Country)	(Day/Month/Year Filed)  (Day/Month/Year Filed)	
2002-318910 (Number)	s)	(Country)	(Day/Month/Year Filed)	Yes No
(Number)  (Number)  (Number)  hereby claim the benefit un f the claims of this applicat Code, §112, I acknowledge t	der Title 35, United Stat ion is not disclosed in th the duty to disclose mate	(Country)  (Country)  (Country)  tes Code §120 of any United States applicate	(Day/Month/Year Filed)  (Day/Month/Year Filed)  (Day/Month/Year Filed)  States application(s) listed below and, insoft ion in the manner provided by the first para Title 37, Code of Federal Regulations §1.5	Yes No Yes No ar as the subject matter of graph of Title 35, United
(Number)  (Number)  (Number)  hereby claim the benefit unf the claims of this application, §112, I acknowledge telephone (Number)	der Title 35, United Stat ion is not disclosed in th the duty to disclose mate plication and the nationa	(Country)  (Country)  (Country)  tes Code §120 of any United States applicate and information as defined in	(Day/Month/Year Filed)  (Day/Month/Year Filed)  (Day/Month/Year Filed)  States application(s) listed below and, insoft ion in the manner provided by the first para Title 37, Code of Federal Regulations §1.5	Yes No Yes No Yes No Far as the subject matter of agraph of Title 35, United 36(a) which occurred between

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Docket No.:

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the Untied States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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